



Micron Selected to Help Alcatel-Lucent Accelerate Information Sharing Across Global Broadband Networks

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BOISE, Idaho, June 28, 2011 (GLOBE NEWSWIRE) -- To meet the rising global demand for information from across the Internet, Micron Technology, Inc. (Nasdaq:MU), today announced that Alcatel-Lucent has chosen Micron's third-generation reduced latency DRAM (RLDRAM 3 memory) to drive Alcatel-Lucent's next generation of network offerings. A leader in fixed, mobile and converged broadband networking solutions, Alcatel-Lucent plans to rely on Micron's RLDRAM 3 memory to support the industry's first 400-gigabit (Gb) capable chipset.

Micron's third generation of RLDRAM memory was developed to enable a faster, more efficient transfer of data over the network by doubling performance to 76.8 Gb/s and cutting latency to below 10 nanoseconds. Both improvements help networking segment customers meet the broadband infrastructure's rapidly evolving demands.

"Service providers are starting to combine residential, business and mobile services onto a single IP network," said Ken Kutzler, Vice President of Hardware Development for Alcatel-Lucent's IP Division. "Micron's state-of-the-art memory enables leading IP equipment suppliers like Alcatel-Lucent to help service providers meet the planet's voracious appetite for data."

Micron and Alcatel-Lucent have collaborated on many fronts for more than a decade. The integration of RLDRAM memory—from Micron's definition phase to early production—into these latest Alcatel-Lucent products has been a three year journey. Micron is expected to begin production of RLDRAM 3 memory during the second half of 2011. Information on ordering RLDRAM 3 product samples can be found on Micron's [Web site](#).

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About Micron

Micron Technology, Inc., is one of the world's leading providers of advanced semiconductor solutions. Through its worldwide operations, Micron manufactures and markets a full range of DRAM, NAND and NOR flash memory, as well as other innovative memory technologies, packaging solutions and semiconductor systems for use in leading-edge computing, consumer, networking, embedded and mobile products. Micron's common stock is traded on the NASDAQ under the MU symbol. To learn more about Micron Technology, Inc., visit www.micron.com.

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This press release contains forward-looking statements regarding production of RLDRAM 3. Actual events or results may differ materially from those contained in the forward-looking statements. Please refer to the documents Micron files on a consolidated basis from time to time with the Securities and Exchange Commission, specifically Micron's most recent Form 10-K and Form 10-Q. These documents contain and identify important factors that could cause the actual results for Micron on a consolidated basis to differ materially from those contained in our forward-looking statements (see Certain Factors). Although we believe that the expectations reflected in the forward-looking statements are reasonable, we cannot guarantee future results, levels of activity, performance or achievements.

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